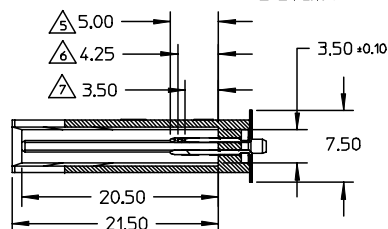
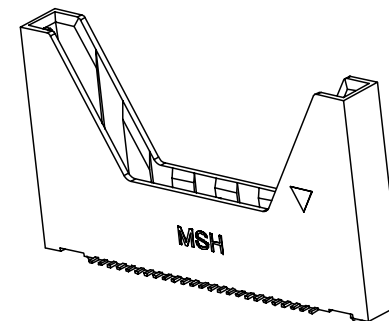


Detail1



SECTION A-A



## NOTES:

## 1 MATERIAL:

1-1 HOUSING: LIQUID CRYSTAL POLYMER(LCP), GLASS FIBER FILLED,  
UL94 V-0, COLOR: BLACK

## 1-2 TERMINAL: COPPER ALLOY

## 2 TERMINAL FINISH:

15μ GOLD PLATING ON CONTACT AREA

150μ TIN-LEAD ALLOY ON SOLDER TAIL AREA

50μ NICKEL(Ni) OVERALL

## 3 RECOMMENDED CARD THICKNESS OF CONNECTING AREA: 3.3mm +/- 0.1mm

## 4 RECOMMENDED CARD WIDTH : 42.8mm +/- 0.1mm

△ THE DIMENSION APPLIES TO CIRCUIT NUMBERS: 1, 13, 38 AND 50

△ THE DIMENSION APPLIES TO OTHER CIRCUIT NUMBERS EXCEPT FOR

1, 13, 38, 50, 25, 26



△ THE DIMENSION APPLIES TO CIRCUIT NUMBERS : 25 AND 26

## 8 PIN DIAMETER IS 0.44±0.02

## 9 TOTAL COPLANARITY OF SOLDER TAILS AND NAILS TO BE 0.10mm MAX

## 10 PRODUCT SPECIFICATION: PS-47026-001

## 11 PACKING METHOD: TUBE

NEW RELEASE EC NO: SH2004-0022 DRWN: XIXU 2003/11/21 CHKD: JLU 2003/11/25 APPR: SHUANG 2003/11/26	QUALITY SYMBOLS	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		SCALE 2:1	DESIGN UNITS METRIC		THIRD ANGLE PROJECTION	REVISE ON CAD ONLY					
					DIMENSION STYLE		TITLE  ASSEMBLY VERTICAL SMT CF CARD 50P HEADER TYPE I  MOLEX INCORPORATED							
					MM ONLY									
					DRAWN BY DATE									
					XU XIANG 2003-11-06									
					CHECKED BY DATE									
					JLU 2003-11-06		 MOLEX INCORPORATED		MATERIAL NO. 470260001		DOCUMENT NO. SD-47026-001		SHEET NO. 1 OF 1	
					APPROVED BY DATE									
					SHUANG 2003-11-06									